Declaration of Conformity
According to EN 45014 and Article 10 of Council Directive 2004/108/EC

Manufacturer's Name:	Seagate Technology LLC
Manufacturer's Address:	10200 S. De Anza Blvd.
(And Importer)	Cupertino, CA 95014-3029 USA
European Contact:	Director of Operations Seagate Technology International Koolhovenlaan 1 1119 NB Schiphol Rijk The Netherlands
Type of Equipment:	HDD
Product Name:	**Constellation ES.3**
Year begin affixing Mark:	**2012**

Seagate Technology, Incorporated hereby declares that the equipment specified above conforms with the protection requirements of the EU Directives and Standards listed below;

EU Electromagnetic Compatibility (EMC) Directive 2004/108/EC

EN 55022:2010 - Class B ITE "Limits and methods of measurement of radio disturbance characteristics of information technology equipment"

EN 61000-3-2:2006+A1(2009)+A2(2009) "Limits for Harmonic Current Emissions (Equipment Input Current Less Than/Equal to 16 A per Phase)"

EN 61000-3-3:2008 "Limitation of Voltage Fluctuations and Flicker in Low-Voltage Supply Systems for Equipment with Rated Current Less Than or Equal to 16 A"

EN 55024:2010 "Information technology equipment- Immunity characteristics- Limits and methods of measurement."

EN61000-4-2: Electrostatic Discharge Requirements
EN61000-4-3: Radiated Electromagnetic Field Requirements
EN61000-4-4: Electrical Fast Transient/Burst Requirements
EN61000-4-5: Surge Immunity Test
EN61000-4-6: Immunity to Conducted Disturbances, Induced by Radio-Frequency Fields
EN61000-4-8: Power Frequency, Magnetic Field Immunity Test
EN61000-4-11: Voltage Dips, Short Interruptions and Voltage Variations Immunity Test

EU Low Voltage Directive 2006/95/EEC

EN 60950-1:2005, Second Edition AM 1:2009 "Safety requirements of information technology equipment including electrical machines designed for use with certain voltage limits"

EN 60950-1:2006 + A11:2009 + A1:2010 + A12:2011 "Information technology equipment. Safety. General requirements."

EU RoHS Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment, with the following exemptions that are listed per Annex released 24 September, 2010:

6a. Lead as an alloying element in steel containing up to 0.35% lead by weight
6b. Lead as an alloying element in aluminum up to 0.4% lead by weight
6c. Lead as an alloying element in copper containing up to 4% lead by weight
7a. Lead in high melting temperature type solders (i.e. lead-based solder alloys containing 85 % by weight or more lead)
7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound

Sai Varanasi

Digitally signed by Savcenco Oleg
Date: 2024.08.30 11:38:56 EEST
Reason: MoldSign Signature
Location: Moldova
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Sai Varanasi
Vice President
PSG Design Center Reliability

09 November 2012